

Renesas RA Family

EK-RA6E2 Example Project Bundle

Introduction

This document describes the contents of the Example Project Bundle for the EK-RA6E2 kit. The Example Projects contained within the bundle show how to write code for the various Renesas Flexible Software Package (FSP) modules supported by the EK-RA6E2 kit.

Flexible Software Package is an optimized software package designed to provide easy to use, scalable, high-quality software for embedded system design. The primary goal is to provide lightweight, efficient drivers that meet common use cases in embedded systems. FSP code quality is enforced by peer reviews, automated requirements-based testing, and automated static analysis. FSP provides uniform and intuitive APIs that are well documented. Each module is supported with detailed user documentation including example code. FSP modules can be used on any MCU in the RA family, provided the MCU has any peripherals required by the module. FSP modules can be configured at build-time to optimize the size of the module for the feature set required by the application.

Supported Kit

EK-RA6E2

Supported FSP Version

FSP v6.0.0

Supported Toolchains

For the latest version of each Integrated Development Environment (IDE) and toolchain listed below, please refer to the FSP release notes

- e² studio with GCC Arm Embedded (GCC) or LLVM embedded toolchain for Arm (LLVM)
- Keil MDK with Arm compiler toolchain
- IAR EWARM with IAR toolchain for Arm

1. Using the Example Projects

To use EK-RA6E2 Example Projects, follow the steps mentioned in the following documents:

- Example Project Usage Guide https://github.com/renesas/ra-fsp-examples/blob/master/example_projects/Example%20Project %20Usage%20Guide.pdf
- e² studio AC6 porting Guide <u>https://en-support.renesas.com/knowledgeBase/19375553</u>

Users who are new to the FSP are recommended to refer to the section **Starting Development > Tutorial: Your First RA MCU Project – Blinky** in the <u>RA FSP Documentation</u> prior to attempting to program or debug an example project.



2. List of Example Projects Supported on Different Toolchains in the Bundle

The following table lists example projects supported by each IDE. These are ready to import using the import process for each IDE.

Note:

- 1. Additional example projects other than those mentioned above, may be available in the <u>example</u> <u>project repository</u>. However, they are supported with older version of FSP. Please refer the example_projects/version_info_table.md file in the repository to identify the appropriate FSP version for the example project of interest.
- 2. All projects supported by e^2 studio/GCC are supported with e^2 studio/AC6 via port from GCC.

	IDE Support		
Example Project	e ² studio	IAR	Keil MDK
FileX_block_media_qspi_LevelX	Supported		
USBX_phid	Supported		
USBX_pprn	Supported		
_quickstart	Supported		
adc	Supported		
adc_gpt_periodic_sampling	Supported		
agt	Supported	Supported	Supported
audio_playback_pwm	Supported		
baremetal	Supported		
cac	Supported		
can_fd	Supported		
clock_output	Supported		
срр	Supported		
crc	Supported		
dac	Supported		
dac_agt_periodic_signal_generator	Supported		
dmac	Supported	Supported	Supported
doc	Supported		
elc	Supported		
flash_hp	Supported	Supported	Supported
freertos	Supported	Supported	Supported
gpt	Supported	Supported	Supported
gpt_input_capture	Supported		
i3c_master	Supported		
i3c_slave	Supported		
icu	Supported	Supported	Supported
iwdt	Supported		
lpm	Supported		
lvd	Supported		
qspi	Supported		
rtc	Supported	Supported	Supported
sci_i2c_master	Supported		
sci_spi	Supported	Supported	Supported
sci_uart	Supported	Supported	Supported
smbus	Supported		
spi	Supported	Supported	Supported
ssi	Supported		

Table 1. IDE Support for the Example Project



	IDE Support		
Example Project	e ² studio	IAR	Keil MDK
ssi_slave	Supported		
tfu	Supported		
usb_pcdc	Supported		
usb_phid	Supported		
usb_pvnd	Supported		
vee_flash	Supported		
wdt	Supported	Supported	Supported
wifi_on_chip_http_client	Supported		
trustzone/agt	Supported	Supported	Supported
trustzone/doc	Supported	Supported	Supported
trustzone/rtc	Supported	Supported	Supported
trustzone/usb_phid	Supported	Supported	Supported



3. Running the Project

1. Open RTT Viewer by double clicking JLinkRTTViewer.exe in the downloaded /Segger/JLink folder.

SEGGER > JLink > - + + Search JLink				
New folder	E	= - 1 0		
Name	Date modified	Туре		
JLinkDLLUpdater.exe	9/6/2019 12:00 PM	Application		
JLinkGDBServer.exe	9/6/2019 12:00 PM	Application		
🔜 JLinkGDBServerCL.exe	9/6/2019 12:00 PM	Application		
🔜 JLinkLicenseManager.exe	9/6/2019 12:00 PM	Application		
JLinkRDI.dll	9/6/2019 12:00 PM	Application exten		
JLinkRDIConfig.exe	9/6/2019 12:00 PM	Application		
ILinkRegistration.exe	9/6/2019 12:00 PM	Application		
ILinkRemoteServer.exe	9/6/2019 12:00 PM	Application		
ILinkRemoteServerCL.exe	9/6/2019 12:00 PM	Application		
ILinkRTTClient.exe	9/6/2019 12:00 PM	Application		
ILinkRTTLogger.exe	9/6/2019 12:01 PM	Application		
JLinkRTTViewer.exe	9/6/2019 12:01 PM	Application		
JLinkSTM32.exe	9/6/2019 12:01 PM	Application		
ILinkSTR91x.exe	9/6/2019 12:01 PM	Application		

2. On opening, the field **Specify Target Device** shows up as **unspecified**. With USB selected, click on the tab and select the desired Renesas RA device. Keep a note the Core type.

	🛃 J-Link RTT Viewer Configuration
	Connection to J-Link US8 Serial No TCP/IP Existing Session
	Specify Target Device
	unspecified 👻
	Script file (optional)
	Target Interface & Speed
	SWD • 4000 kHz •
	RTT Control Block O Address O Search Range J-Link automatically detects the RTT control block.
l	OK Cancel

3. If multiple kits are connected to the PC, make sure to choose the corresponding serial number. The default is 0.

Note: For MCUs such as RA6M4, RA6M5, RA4E1, RA6E2, and RA6T2, the exact address of the RTT Control Block must be specified. When Auto Detection is used, RTT Viewer parses all RAM memory to find the RTT Block. As TrustZone boundaries are configured for all projects for these MCUs, RTT Viewer will encounter access failures and you will not see the output logs in RTT viewer. The exact address for the SEGGER_RTT data structure in RAM is found in the readme.txt file associated with the module under evaluation or in the map file when a binary is built. (Refer Appendix for an example).



Connection to J-Link USB VSB VSB
O TCP/IP
Existing Session
Specify Target Device
R7FA6M1AD 👻 📖
Script file (optional)
Target Interface & Speed
SWD • 4000 kHz •
RTT Control Block
Auto Detection Address Search Range
3-Link automatically detects the RTT control block.
3-Link automatically detects the RTT control block. OK Cancel

4. For parts other than Cortex-M33, click **OK**. For MCUs based on Cortex M33 Core, refer the Appendix.

J-Link RTT Viewer Co	nfiguration	? ×
Connection to J-Link		
	0	
TCP/IP		
Existing Session		
Specify Target Device		
R7FA6M1AD		•
Script file (optional)		
Target Interface & Speed		
SWD	•	4000 kHz 💌
RTT Control Block		
Auto Detection O Address	💮 Se	arch Range
J-Link automatically detects the RTI	Control block	

5. Click on the **Input** tab and change **Sending** option to **Send on Enter**. Every time input in entered, you must either press the **Enter** or **Enter** tab on the RTT viewer.



Els Terminals I to	and I amples - Hale			
Life Jerminais [10]	put Logging Help			
Log All Termin	<u>C</u> lear Input field			
00>	Sending •	Send on Input		
00> * Ren	End of Line +	Send on Enter	fodule	*
00> * Exa	Echo jnput >	✓ Block if FIFO full	100012C	
	Contrained and a	BIOCK IT PIPO TUII		
00> ********	***********	**************	***********	********
00> Refer to :	eadme.txt file	for more details	on Example Pro	ject and
		re information ab		
00>				
00> The project	t initializes	the ADC in single	scan or contin	uous scan mode
00> based on t	ser selection	in RA configurato	r.Once initiali	zed, user can sta
00> the ADC so	can and also st	op the scan (in t	he case of cont	inuous scan mode
	kRTTViewer by	sending commands.	Results are dis	played JLinkRTTV
<00>				
00> MENU to Se				
	Start ADC Sca			
		(Only for Continu	ious mode)	
00> User Input				
•				
			[Enter Clear
TT Viewer connected			0.00	0 MB
11 viewer connected			0.00	U MB

Follow the instructions displayed on the RTT Viewer as shown above. Also refer to readme.txt file in the project folder (downloaded.zip file or in <u>https://github.com/renesas/ra-fsp</u>) to run the project.



Appendix

a. Limitations in connecting with J-Link RTT Viewer v7.68b or later

When using Auto Detection option for the RTT Control Block, J-Link RTT Viewer may not be able to find the SEGGER_RTT variable in RAM memory due to restrictions on memory access imposed by TrustZone settings made by the Renesas Device Partition Manager. Restrictions are typically applied for TrustZone Example Projects If the RTT Control Block cannot be found by RTT Viewer, then output from an Example Project may not be visible in the RTT Viewer Console with Auto Detection.

🔛 J-Link RTT Viewer V6.86 Configuration ? 🗙
Connection to J-Link ● USB ☑ Serial No 0
Specify Target Device R7FA6M3AH V
Script file (optional)
Target Interface & Speed
SWD 🔹 4000 kHz 💌
RTT Control Block
Auto <u>D</u> etection <u>A</u> ddress <u>Search Range</u>
J-Link automatically detects the RTT control block.
OK Cancel

To mitigate this situation, you may use any one of the following approaches:



1. **Method 1:** The recommended approach is to search _SEGGER_RTT variable in the map file, generated upon successfully building a configuration of an Example Project, which is by default located in the address space for On-chip SRAM.

> 😕 ra_gen	
> 🐸 src	
✓ ➢ Debug	
> 👝 ra	
> 👝 ra_gen	
> 🗁 src	
> 🔜 secure.o - [arm/le]	
> 🐝 usb_phid_ns_ek_ra6m4_ep.elf - [arm/le]	
🗋 makefile	
📄 makefile.init	
📄 memory_regions.ld	
objects.mk	
🚡 sources.mk	
📄 usb_phid_ns_ek_ra6m4_ep.elf.in	
📄 usb_phid_ns_ek_ra6m4_ep.map	
📄 usb_phid_ns_ek_ra6m4_ep.srec	

COMMON	0x20005f1c	0xa8 ./src/SEGGER_RTT/SEGGER_RTT.o	
	0x20005f1c	SEGGER RTT	
COMMON	0x20005fc4 0x20005fc4 0x2000600c	0x51 ./ra_gen/main.o g_fsp_common_initialized_semaphore_memory g_fsp_common_thread_count	

And input the exact address of the variable into the Address Input.

🔝 J-Link RTT Viewer V7.64b Configuration 🛛 🗙
Connection to J-Link ① USB ☑ Serial No ①
○ <u>T</u> CP/IP
C Existing Session
Specify Target Device
R7FA6M3AH ~
Force go on connect
Script file (optional)
Target Interface & Speed
SWD 🔻 4000 kHz 👻
RTT Control Block
○ Auto <u>D</u> etection
Enter the address of the RTT Control block. Example: 0x20000000
0x20005F1C
OK Cancel

2. **Method 2:** Apply a search range within the first 32kB of SRAM Memory. This approach works when the compiler places _SEGGER_RTT variable in the first 32kB of SRAM memory.



🔜 J-Link RTT Viewer V6.86 Configuration	?	×
Connection to J-Link USB Serial No 0		
<u>T</u> CP/IP <u>Existing Session</u>		
Specify Target Device		
R7FA6M3AH	~	
Script file (optional)		
Target Interface & Speed		
SWD	4000 kHz	•
RTT Control Block Auto Detection Address Enter one or more address range(s) the RTT Control block can be located syntax: Syntax: RangeStart [Hex] > <rangesize>[, <range [hex]="" istart=""> <</range></rangesize>	ed in.	>,]
0x20000000 0x8000		
OK	Can	cel



Website and Support

Visit the following URLs to learn about key elements of the RA family, download components and related documentation, and get support.

RA Product Information RA Product Support Forum RA Flexible Software Package Renesas Support renesas.com/ra renesas.com/ra/forum renesas.com/FSP renesas.com/support



Revision History

		Descript	ion
Rev.	Date	Page	Summary
1.00	Mar.15.23	—	First release document.
1.01	Mar.29.23	—	Second release document.
1.02	Apr.28.23	—	Added support for FSP v4.4.0 (1).
1.03	Jun.01.23	—	Added support for FSP v4.4.0 (2).
1.04	Jul.17.23	—	Added support for FSP v4.5.0 (1).
1.05	Sep.18.23	—	Added support for FSP 4.5.0 (2).
1.06	Sep.26.23	—	Added support for FSP v4.6.0 (1).
1.07	Oct.23.23	—	Added support for FSP v4.6.0 (2).
1.08	Nov.06.23	—	Added support for FSP v5.0.0 (2).
1.09	Dec.05.23	—	Added support for FSP v5.0.0 (3).
1.10	Dec.19.23	—	Added support for FSP v5.1.0 (2).
1.11	Jan.29.24	—	Added support for FSP v5.1.0 (4).
1.12	Mar.11.24	—	Added support for FSP v5.2.0 (1).
1.13	Mar.21.24	—	Added support for FSP v5.2.0 (2).
1.14	Apr.09.24	—	Added support for FSP v5.2.0 (3).
1.15	May.09.24	_	Added support for FSP v5.3.0 (1).
1.16	Jun.14.24	—	Added support for FSP v5.3.0 (3).
1.17	Jul.05.24	_	Added support for FSP v5.4.0 (1).
1.18	Aug.15.24	—	Added support for FSP v5.4.0 (2).
1.19	Sep.10.24	—	Added support for FSP v5.5.0 (1).
1.20	Oct.14.24	_	Added support for FSP v5.5.0 (2).
1.21	Dec.17.24	-	Added support for FSP v5.7.0 (1).
1.22	Feb.28.25	-	Added support for FSP v5.8.0 (2).
1.23	Apr.28.25	-	Added support for FSP v5.9.0 (2).
1.24	Jun.06.25	-	Added support for FSP v5.9.0 (3).
1.25	Jul.08.25	-	Added support for FSP v6.0.0 (2).



General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices.

2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power is supplied until the power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable. 6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (Max.) and V_{IH} (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (Max.) and V_{IH} (Min.).

7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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